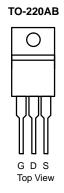


N-Channel 40-V (D-S) MOSFET

PRODUCT SUMMARY		
V _{DS}	40	V
$R_{DS(on)} V_{GS} = 10 V$	2	mΩ
I _D	180	А
Configuration	Sin	gle

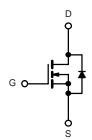


FEATURES

- TrenchFET[®] Power MOSFET
- 100 % R_g and UIS Tested

APPLICATIONS

- Synchronous Rectification
- Power Supplies



N-Channel MOSFET

ABSOLUTE MAXIMUM RATINGS	T _A = 25 °C, unle	ss otherwise no	ted	
Parameter		Symbol	Limit	Unit
Train-Source VoltageGate-Source VoltageGate-Source VoltageContinuous Drain Current ($T_J = 175 ^{\circ}$ C) $T_C = 25 ^{\circ}$ C $T_A = 25 ^{\circ}$ C $T_A = 70 ^{\circ}$ CPulsed Drain CurrentAvalanche Current PulseSingle Pulse Avalanche EnergyContinuous Source-Drain Diode Current $T_C = 25 ^{\circ}$ C $T_A = 25 ^{\circ}$ C $T_C = 70 ^{\circ}$ C	V _{DS}	40	V	
	V _{GS}	± 20	v	
	$T_{\rm C} = 70 ^{\circ}{\rm C}$ 150 ^c		180 ^{a, c}	
Continuous Drain Current (T $= 175$ °C)				
Continuous Drain Current $(T_j = T/5 C)$	T _A = 25 °C	I _D	29 ^b	A
	T _A = 70 °C		23 ^b	A
Pulsed Drain Current		I _{DM}	350	
Avalanche Current Pulse	$T_{C} = 25 \text{ °C}$ $T_{C} = 70 \text{ °C}$ $T_{A} = 25 \text{ °C}$ $T_{A} = 70 \text{ °C}$ $L = 0.1 \text{ mH}$ $T_{C} = 25 \text{ °C}$ $T_{A} = 25 \text{ °C}$ $T_{C} = 25 \text{ °C}$ $T_{C} = 70 \text{ °C}$	I _{AS}	80	
Single Pulse Avalanche Energy	L = 0.1 IIIH	E _{AS}	320	mJ
Continuous Source Drain Diede Current	T _C = 25 °C	la la	110 ^{a, c}	А
Continuous Source-Drain Diode Current	T _A = 25 °C	I _S	2.6 ^b	A
	T _C = 25 °C		312 ^a	
Maximum Paular Dissinction	T _C = 70 °C	PD	200	w
Maximum Power Dissipation	T _A = 25 °C	FD -	3.13 ^b	vv
	T _A = 70 °C		2.0 ^b	\neg
Operating Junction and Storage Temperature Ra	nge	T _J , T _{stg}	- 55 to 150	°C

THERMAL RESISTANCE RATINGS					
Parameter		Symbol	Typical	Maximum	Unit
Maximum Junction-to-Ambient ^b	Steady State	R _{thJA}	32	40	°C/W
Maximum Junction-to-Case	Steady State	R _{thJC}	0.33	0.4	0/2

Notes:

a. Based on T_C = 25 °C.

b. Surface Mounted on 1" x 1" FR4 board.

c. Calculated based on maximum junction temperature. Package limitation current is 110 A.



SPECIFICATIONS $T_J = 25 \text{ °C}, 0$					L	
Parameter	Symbol	Test Conditions	Min.	Тур.	Max.	Unit
Static			10	1	1	1
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 V, I_D = 250 \mu A$	40			V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	I _D = 250 μA		41		mV/°C
V _{GS(th)} Temperature Coefficient	$\Delta V_{GS(th)}/T_J$	_		- 8		
Gate-Source Threshold Voltage	V _{GS(th)}	$V_{DS} = V_{GS}, I_D = 250 \ \mu A$	2.0		4.0	V
Gate-Source Leakage	I _{GSS}	$V_{DS} = 0 V, V_{GS} = \pm 20 V$			± 100	nA
Zero Gate Voltage Drain Current	I _{DSS}	$V_{DS} = 40 V, V_{GS} = 0 V$			$\begin{array}{c c c c c c c c c } 8 & & & & & & \\ \hline & 4.0 & V \\ \hline & \pm 100 & & & \\ \hline & \pm 100 & & & \\ \hline & & & & & \\ \hline & & & & & \\ \hline & & & &$	
Zere Cate Venage Drain Carrent	-033	V_{DS} = 40 V, V_{GS} = 0 V, T_{J} = 55 °C			10	μ/ (
On-State Drain Current ^a	I _{D(on)}	$V_{DS} \ge 5$ V, V_{GS} = 10 V	120			A
Drain-Source On-State Resistance ^a	Base	$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 30 \text{ A}$		2		
Drain-Source On-State Resistance-	R _{DS(on)}	$V_{GS} = 4.5 \text{ V}, \text{ I}_{D} = 20 \text{ A}$		15		1115.2
Forward Transconductance ^a	9 _{fs}	$V_{DS} = 15 \text{ V}, \text{ I}_{D} = 30 \text{ A}$		180		S
Dynamic ^b					-	
Input Capacitance	C _{iss}			9000		pF
Output Capacitance	C _{oss}	V_{DS} = 20 V, V_{GS} = 0 V, f = 1 MHz		650		
Reverse Transfer Capacitance	C _{rss}			450		
Total Gate Charge	Qg			120		
Gate-Source Charge	Q _{gs}	$V_{DS} = 20$ V, $V_{GS} = 10$ V, $I_{D} = 20$ A		30		nC
Gate-Drain Charge	Q _{gd}			16		
Gate Resistance	Rg	f = 1 MHz		0.85	1.3	Ω
Turn-On Delay Time	t _{d(on)}			20	30	
Rise Time	t _r	$V_{DD} = 20 \text{ V}, \text{ R}_{L} = 1.0 \Omega$		11	17	
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 20 \text{ A}, \text{ V}_{\text{GEN}} = 10 \text{ V}, \text{ R}_{\text{g}} = 1 \Omega$		77	115	
Fall Time	t _f			10	15	
Turn-On Delay Time	t _{d(on)}			102	155	ns
Rise Time	t _r	$V_{DD} = 20 \text{ V}, \text{ R}_{L} = 1.0 \Omega$		62	95	-
Turn-Off Delay Time	t _{d(off)}	$I_D \cong 20$ Å, V_{GEN} = 4.5 V, R_g = 1 Ω		180	270	
Fall Time	t _f			60	90	
Drain-Source Body Diode Characteristic	s					
Continuous Source-Drain Diode Current	ا _S	T _C = 25 °C			110	
Pulse Diode Forward Current ^a	I _{SM}				200	A
Body Diode Voltage	V _{SD}	I _S = 20 A		0.8	1.2	V
Body Diode Reverse Recovery Time	t _{rr}			50	75	ns
Body Diode Reverse Recovery Charge	Q _{rr}			70	105	nC
Reverse Recovery Fall Time	t _a	$I_F = 20 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s}, T_J = 25 \text{ °C}$		30	1	
Reverse Recovery Rise Time	t _b			20		ns

emi

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Notes:

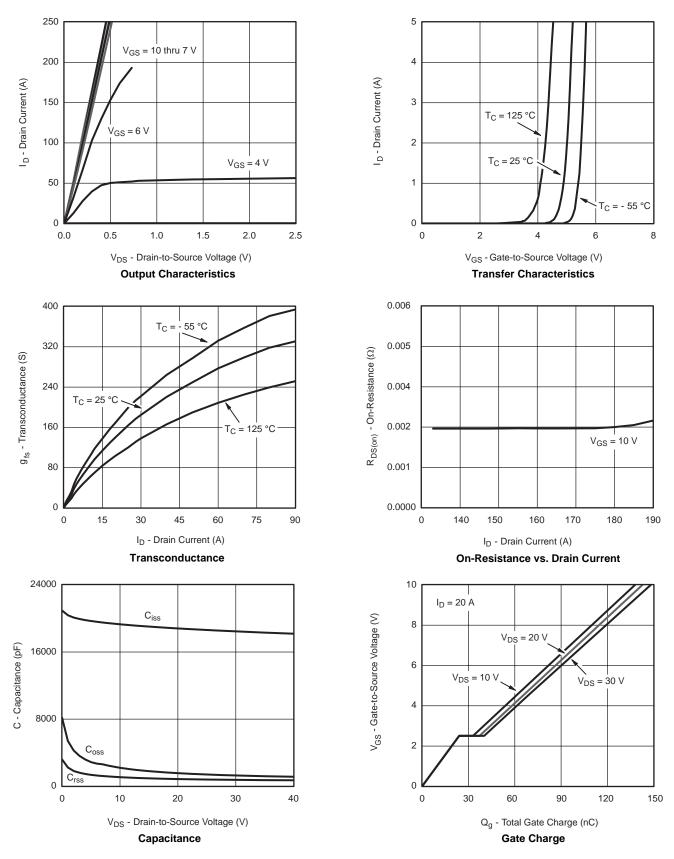
a. Pulse test; pulse width \leq 300 $\mu s,$ duty cycle \leq 2 %.

b. Guaranteed by design, not subject to production testing.

Stresses beyond those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated in the operational sections of the specifications is not implied. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

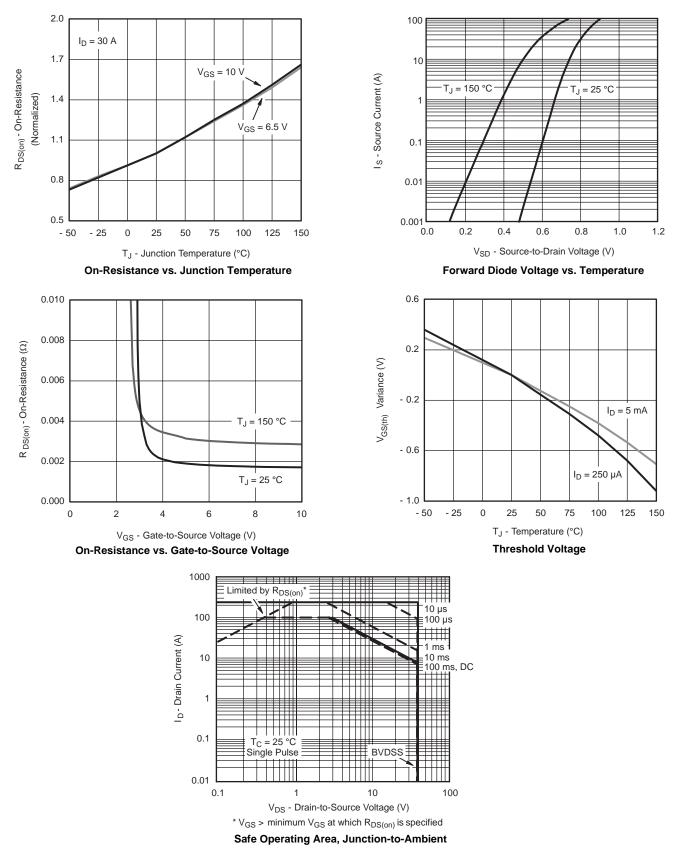


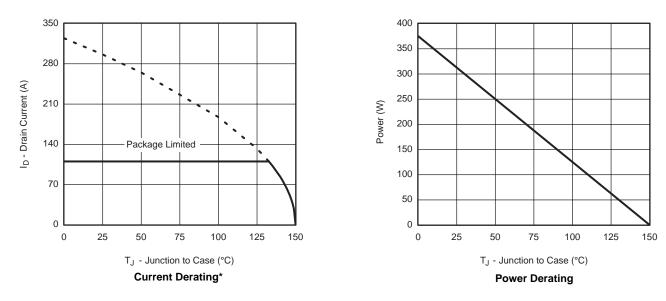
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





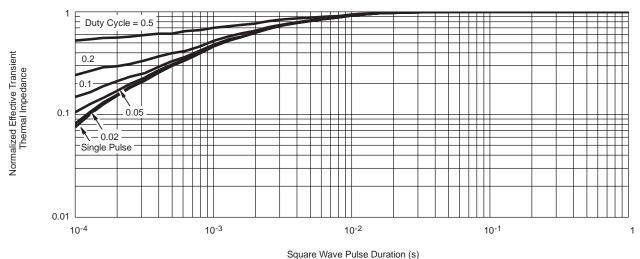
TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted





TYPICAL CHARACTERISTICS 25 °C, unless otherwise noted

* The power dissipation P_D is based on $T_{J(max)}$ = 150 °C, using junction-to-case thermal resistance, and is more useful in settling the upper dissipation limit for cases where additional heatsinking is used. It is used to determine the current rating, when this rating falls below the package limit.

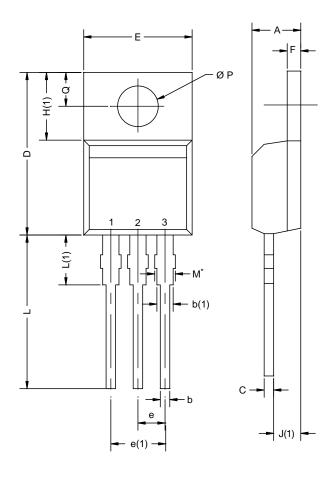


Normalized Thermal Transient Impedance, Junction-to-Case

Bsemi.com



TO-220AB



DIM.	MILLIM	IETERS	INCHES		
	MIN.	MAX.	MIN.	MAX.	
А	4.25	4.65	0.167	0.183	
b	0.69	1.01	0.027	0.040	
b(1)	1.20	1.73	0.047	0.068	
С	0.36	0.61	0.014	0.024	
D	14.85	15.49	0.585	0.610	
Е	10.04	10.51	0.395	0.414	
е	2.41	2.67	0.095	0.105	
e(1)	4.88	5.28	0.192	0.208	
F	1.14	1.40	0.045	0.055	
H(1)	6.09	6.48	0.240	0.255	
J(1)	2.41	2.92	0.095	0.115	
L	13.35	14.02	0.526	0.552	
L(1)	3.32	3.82	0.131	0.150	
ØΡ	3.54	3.94	0.139	0.155	
Q	2.60	3.00	0.102	0.118	

Notes

* M = 1.32 mm to 1.62 mm (dimension including protrusion) Heatsink hole for HVM



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